# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Texas Instruments SN75ALS176D

For any questions, you can email us directly: <a href="mailto:sales@integrated-circuit.com">sales@integrated-circuit.com</a>



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

- Meet or Exceed the Requirements of TIA/EIA-422-B, TIA/EIA-485-A<sup>†</sup> and ITU Recommendations V.11 and X.27
- Operate at Data Rates up to 35 Mbaud
- Four Skew Limits Available: SN65ALS176...15 ns

SN75ALS176 . . . 10 ns

SN75ALS176A . . . 7.5 ns SN75ALS176B . . . 5 ns

- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- Low Supply-Current Requirements
   ... 30 mA Max
- Wide Positive and Negative Input/Output Bus-Voltage Ranges
- Thermal Shutdown Protection
- Driver Positive and Negative Current Limiting
- Receiver Input Hysteresis
- Glitch-Free Power-Up and Power-Down Protection
- Receiver Open-Circuit Fail-Safe Design

#### 

**DOR PPACKAGE** 

#### description

The SN65ALS176 and SN75ALS176 series differential bus transceivers are designed for bidirectional data communication on multipoint bus transmission lines. They are designed for balanced transmission lines and meet TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendations V.11 and X.27.

The SN65ALS176 and SN75ALS176 series combine a 3-state, differential line driver and a differential input line receiver, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, that can be connected together externally to function as a direction control. The driver differential outputs and the receiver differential inputs are connected internally to form a differential input/output (I/O) bus port that is designed to offer minimum loading to the bus when the driver is disabled or  $V_{CC} = 0$ . This port features wide positive and negative common-mode voltage ranges, making the device suitable for party-line applications.

The SN65ALS176 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C. The SN75ALS176 series is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

† These devices meet or exceed the requirements of TIA/EIA-485-A, except for the Generator Contention Test (para. 3.4.2) and the Generator Current Limit (para. 3.4.3). The applied test voltage ranges are –6 V to 8 V for the SN75ALS176, SN75ALS176A, and SN75ALS176B and –4 V to 8 V for the SN65ALS180.



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### **AVAILABLE OPTIONS**

		PACKAGED	DEVICES
TA	<sup>t</sup> sk(lim) <sup>†</sup>	SMALL OUTLINE (D)‡	PLASTIC DIP (P)
	10	SN75ALS176D	SN75ALS176P
0°C to 70°C	7.5	SN75ALS176AD	SN75ALS176AP
	5	SN75ALS176BD	SN75ALS176BP
-40°C to 85°C	15	SN65ALS176D	SN65ALS176P

<sup>†</sup> This is the maximum range that the driver or receiver delay times vary over temperature, V<sub>CC</sub>, and process (device to device).

#### **Function Tables**

#### DRIVER

INPUT	ENABLE	OUTI	PUTS	
D	DE	A B		
Н	Н	Н	L	
L	Н	L	Н	
Х	L	z	Z	

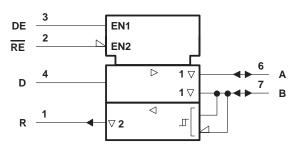
H = high level, L = low level, X = irrelevant, Z = high impedance

#### **RECEIVER**

DIFFERENTIAL INPUTS A-B	ENABLE RE	OUTPUT R
V <sub>ID</sub> ≥ 0.2 V	L	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	L	?
V <sub>ID</sub> ≤ -0.2 V	L	L
X	Н	Z
Inputs open	L	Н

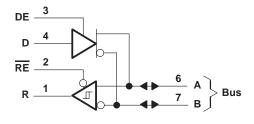
H = high level, L = low level, X = irrelevant, Z = high impedance

#### logic symbol§



§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)





<sup>&</sup>lt;sup>‡</sup> The D package is available taped and reeled. Add the suffix R to the device type (e.g., SN75ALS176DR).

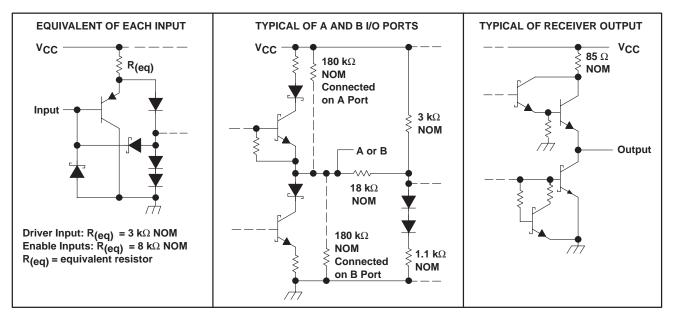
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Voltage range at any bus terminal	–7 V to 12 V
Enable input voltage, V <sub>I</sub>	5.5 V
Package thermal impedance, $\theta_{JA}$ (see Note 2): D package	97°C/W
P package	85°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T <sub>sto</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltage, are with respect to network ground terminal.

2. The package thermal impedance is calculated in accordance with JESD 51.





Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

## SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### recommended operating conditions (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.75	5	5.25	V
Input voltage at any bug terminal (congretaly or common mode). Vi or Vie				12	V
nput voltage at any bus terminal (separately or common mode), V <sub>I</sub> or V <sub>IC</sub>				<b>-</b> 7	V
High-level input voltage, V <sub>IH</sub>	D, DE, and RE	2			V
Low-level input voltage, V <sub>IL</sub>	D, DE, and RE			0.8	V
Differential input voltage, V <sub>ID</sub> (see Note 3)				±12	V
High level output ourront leve	Driver			-60	mA
High-level output current, IOH	Receiver			-400	μΑ
Low-level output current, IOI	Driver			60	mA
Low-level output current, 10L	Receiver			8	IIIA
Operating free-air temperature, Τ <sub>Δ</sub>	SN65ALS176	-40		85	°C
Operating nee-an temperature, 1A	SN75ALS176 series	0		70	C

NOTE 3: Differential input/output bus voltage is measured at the noninverting terminal A with respect to the inverting terminal B.





Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### **DRIVER SECTION**

# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS†	MIN	TYP‡	MAX	UNIT
VIK	Input clamp voltage	I <sub>I</sub> = -18 mA				-1.5	V
VO	Output voltage	I <sub>O</sub> = 0		0		6	V
VOD1	Differential output voltage	I <sub>O</sub> = 0		1.5		6	V
V <sub>OD2</sub>	Differential output voltage	R <sub>L</sub> = 100 Ω,	See Figure 1	1/2V <sub>OD1</sub> or 2§			V
		$R_L = 54 \Omega$ ,	See Figure 1	1.5	2.5	5	V
V <sub>OD3</sub>	Differential output voltage	$V_{test} = -7 \text{ V to } 12 \text{ V},$	See Figure 2	1.5		5	V
Δ V <sub>OD</sub>	Change in magnitude of differential output voltage¶	$R_L$ = 54 $\Omega$ or 100 $\Omega$ ,	See Figure 1			±0.2	V
Voc	Common-mode output voltage	$R_L = 54 \Omega \text{ or } 100 \Omega,$	See Figure 1			3 -1	V
Δ VOC	Change in magnitude of common-mode output voltage¶	$R_L$ = 54 $\Omega$ or 100 $\Omega$ ,	See Figure 1			±0.2	V
1-	Output ourroat	Outputs disabled	V <sub>O</sub> = 12 V			1	A
10	Output current	(see Note 4)	V <sub>O</sub> = -7 V			-0.8	mA
lн	High-level input current	V <sub>I</sub> = 2.4 V				20	μΑ
I <sub>I</sub> L	Low-level input current	V <sub>I</sub> = 0.4 V				-400	μΑ
		V <sub>O</sub> = -4 V	SN65ALS176			-250	
		V <sub>O</sub> = -6 V	SN75ALS176			-250	
los	Short-circuit output current#	V <sub>O</sub> = 0				-150	mA
		VO = VCC				250	
		V <sub>O</sub> = 8 V				250	
loo	Supply current	No load	Outputs enabled		23	30	mA
ICC	опрріу синопі	No load	Outputs disabled		19	26	111/4

<sup>†</sup> The power-off measurement in TIA/EIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.

NOTE 4: This applies for power on and power off. Refer to TIA/EIA-485-A for exact conditions. The TIA/EIA-422-B limit does not apply for a combined driver and receiver terminal.



<sup>&</sup>lt;sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V and  $T_A$  = 25°C.

<sup>§</sup> The minimum  $V_{OD2}$  with a 100- $\Omega$  load is either 1/2  $V_{OD1}$  or 2 V, whichever is greater.

<sup>¶</sup> Δ|V<sub>OD</sub>| and Δ|V<sub>OC</sub>| are the changes in magnitude of V<sub>OD</sub> and V<sub>OC</sub>, respectively, that occur when the input is changed from one logic state to the other.

<sup>#</sup> Duration of the short circuit should not exceed one second for this test.



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

#### **SN65ALS176**

PARAMETER		PARAMETER TEST CONDITIONS			MIN	TYP†	MAX	UNIT
t <sub>d</sub> (OD)	Differential output delay time	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3			15	ns
tsk(p)	Pulse skew <sup>‡</sup>	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3		0	2	ns
tsk(lim)	Pulse skew§	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3			15	ns
t <sub>t</sub> (OD)	Differential output transition time	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3		8		ns
<sup>t</sup> PZH	Output enable time to high level	$R_L = 110 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 4			80	ns
tPZL	Output enable time to low level	$R_L = 110 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 5			30	ns
tPHZ	Output disable time from high level	$R_L = 110 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 4			50	ns
tPLZ	Output disable time from low level	$R_L = 110 \Omega$ ,	C <sub>L</sub> = 50 pF,	See Figure 5			30	ns

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### SN75ALS176, SN75ALS176A, SN75ALS176B

	PARAMETER			TEST CONDITION	NS	MIN	TYP <sup>†</sup>	MAX	UNIT	
		'ALS176				3	8	13		
t <sub>d</sub> (OD)	Differential output delay time	'ALS176A	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3	4	7	11.5	ns	
	delay time	'ALS176B	1			5	8	10		
tsk(p)	Pulse skew‡		$R_L = 54 \Omega$ ,	$C_L = 50 \text{ pF},$	See Figure 3		0	2	ns	
		'ALS176							10	
tsk(lim)	Pulse skew§	'ALS176A	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3			7.5	ns	
		'ALS176B	1					5		
t <sub>t</sub> (OD)	Differential output transit	tion time	$R_L = 54 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 3		8		ns	
<sup>t</sup> PZH	Output enable time to hi	gh level	$R_L = 110 \Omega$ ,	C <sub>L</sub> = 50 pF,	See Figure 4		23	50	ns	
tpZL	Output enable time to lo	w level	$R_L = 110 \Omega$ ,	$C_L = 50 pF$ ,	See Figure 5		14	20	ns	
tPHZ	Output disable time from	n high level	$R_L = 110 \Omega$ ,	C <sub>L</sub> = 50 pF,	See Figure 4		20	35	ns	
tPLZ	Output disable time from	low level	$R_L = 110 \Omega$ ,	C <sub>L</sub> = 50 pF,	See Figure 5		8	17	ns	

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

#### **SYMBOL EQUIVALENTS**

DATA-SHEET PARAMETER	TIA/EIA-422-B	TIA/EIA-485-A
Vo	V <sub>oa</sub> , V <sub>ob</sub>	V <sub>oa</sub> , V <sub>ob</sub>
Vod1	Vo	V <sub>O</sub>
V <sub>OD2</sub>	$V_t (R_L = 100 \Omega)$	$V_t (R_L = 54 \Omega)$
IVOD3I	None	V <sub>t</sub> (test termination measurement 2)
Δ V <sub>OD</sub>	$  V_t  -  \overline{V}_t  $	$  V_t  -  \overline{V}_t  $
Voc	V <sub>os</sub>	V <sub>os</sub>
∆ Voc	$ V_{OS} - \overline{V}_{OS} $	$ V_{OS} - \overline{V}_{OS} $
los	$ I_{sa} ,  I_{sb} $	None
lo	$ I_{xa} ,  I_{xb} $	I <sub>ia</sub> , I <sub>ib</sub>



<sup>‡</sup> Pulse skew is defined as the |tpLH - tpHL| of each channel of the same device.

<sup>§</sup> Skew limit is the maximum difference in propagation delay times between any two channels of any two devices.

<sup>‡</sup> Pulse skew is defined as the |tpLH - tpHL| of each channel of the same device.

<sup>§</sup> Skew limit is the maximum difference in propagation delay times between any two channels of any two devices.



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

# SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### **RECEIVER SECTION**

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
V <sub>IT+</sub>	Positive-going input threshold voltage	$V_0 = 2.7 V$ ,	$I_{O} = -0.4 \text{ mA}$			0.2	V
V <sub>IT</sub> _	Negative-going input threshold voltage	$V_0 = 0.5 V$ ,	I <sub>O</sub> = 8 mA	-0.2‡			V
V <sub>hys</sub>	Hysteresis voltage (V <sub>IT+</sub> – V <sub>IT</sub> –)				60		mV
VIK	Enable-input clamp voltage	I <sub>I</sub> = -18 mA				-1.5	V
VOH	High-level output voltage	V <sub>ID</sub> = 200 mV, See Figure 6	I <sub>OH</sub> = -400 μA,	2.7			V
VOL	Low-level output voltage	V <sub>ID</sub> = -200 mV, See Figure 6	I <sub>OL</sub> = 8 mA,			0.45	V
loz	High-impedance-state output current	V <sub>O</sub> = 0.4 V to 2.4 V				±20	μΑ
\/.	Line input surrent	Other input = 0 V	V <sub>I</sub> = 12 V			1	mA
VI	Line input current	(see Note 5)	V <sub>I</sub> = -7 V			-0.8	mA
lн	High-level-enable input current	V <sub>IH</sub> = 2.7 V				20	μΑ
I <sub>IL</sub>	Low-level-enable input current	V <sub>IL</sub> = 0.4 V				-100	μΑ
rį	Input resistance			12	20		kΩ
los	Short-circuit output current	V <sub>ID</sub> = 200 mV,	V <sub>O</sub> = 0	-15		-85	mA
laa	Supply current	No. Lond	Outputs enabled		23	30	mΛ
Icc	оирріу сипені	upply current No load			19	26	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTE 5: This applies for power on and power off. Refer to TIA/EIA-485-A for exact conditions.



<sup>&</sup>lt;sup>‡</sup> The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

#### **SN65ALS176**

	PARAMETER		NDITIONS	MIN	TYP†	MAX	UNIT
<sup>t</sup> pd	Propagation time	V <sub>ID</sub> = -1.5 V to 1.5 V, See Figure 7	C <sub>L</sub> = 15 pF,			25	ns
<sup>t</sup> sk(p)	Pulse skew§	V <sub>ID</sub> = -1.5 V to 1.5 V, See Figure 7	C <sub>L</sub> = 15 pF,		0	2	ns
tsk(lim)	Pulse skew¶	$R_L = 54 \Omega$ , See Figure 3	C <sub>L</sub> = 50 pF,			15	ns
<sup>t</sup> PZH	Output enable time to high level	$C_L = 15 pF,$	See Figure 8		11	18	ns
tPZL	Output enable time to low level	C <sub>L</sub> = 15 pF,	See Figure 8		11	18	ns
<sup>t</sup> PHZ	Output disable time from high level	C <sub>L</sub> = 15 pF,	See Figure 8			50	ns
t <sub>PLZ</sub>	Output disable time from low level	$C_L = 15 pF,$	See Figure 8			30	ns

 $<sup>^{\</sup>dagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

#### SN75ALS176, SN75ALS176A, SN75ALS176B

	PARAMETER		TEST COI	NDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
	'ALS176	0 45 5	9	14	19			
t <sub>pd</sub>	Propagation time	'ALS176A	$V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$ See Figure 7	$C_L = 15 pF$ ,	10.5	14	18	ns
		'ALS176B	Goo'r igaro'r		11.5	13	16.5	
t <sub>sk(p)</sub>	Pulse skew‡		V <sub>ID</sub> = −1.5 V to 1.5 V, See Figure 7	C <sub>L</sub> = 15 pF,		0	2	ns
		'ALS176	0 50 5			10		
<sup>t</sup> sk(lim)	Pulse skew§	'ALS176A	$R_L = 54 \Omega$ , See Figure 3	$C_L = 50 pF$ ,			7.5	ns
		'ALS176B	- Goo'r igaro o				5	
tPZH	Output enable time to	high level	$C_L = 15 pF,$	See Figure 8		7	14	ns
tPZL	Output enable time to	low level	$C_L = 15 pF,$	See Figure 8		20	35	ns
tPHZ	Output disable time from	m high level	C <sub>L</sub> = 15 pF,	See Figure 8		20	35	ns
tPLZ	Output disable time from	m low level	C <sub>L</sub> = 15 pF,	See Figure 8		8	17	ns

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### PARAMETER MEASUREMENT INFORMATION

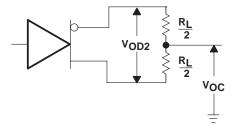


Figure 1. Driver V<sub>OD2</sub> and V<sub>OC</sub>



<sup>§</sup> Pulse skew is defined as the |tpLH - tpHL| of each channel of the same device.

<sup>¶</sup> Skew limit is the maximum difference in propagation delay times between any two channels of any two devices.

<sup>‡</sup>Pulse skew is defined as the |tplH - tpHL| of each channel of the same device.

<sup>§</sup> Skew limit is the maximum difference in propagation delay times between any two channels of any two devices.

Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### PARAMETER MEASUREMENT INFORMATION

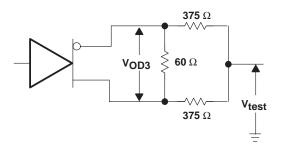
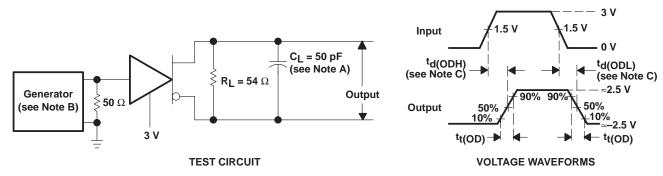


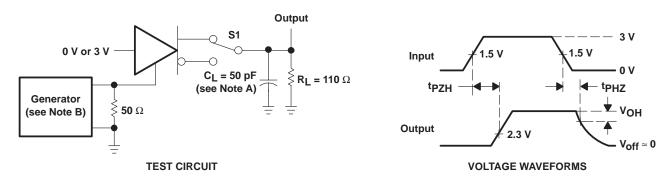
Figure 2. Driver V<sub>OD3</sub>



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle,  $t_{f} \leq$  6 ns,  $t_{f} \leq$  7 ns,  $t_{f} \leq$  8 ns,  $t_{f} \leq$  8 ns,  $t_{f} \leq$  9 ns,  $t_{f} \leq$
- C.  $t_{d(OD)} = t_{d(ODH)}$  or  $t_{d(ODL)}$

Figure 3. Driver Test Circuit and Voltage Waveforms



NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle,  $t_\Gamma \leq$  6 ns,  $t_f \leq$  6 ns,  $t_C = 50 \Omega$ .

Figure 4. Driver Test Circuit and Voltage Waveforms

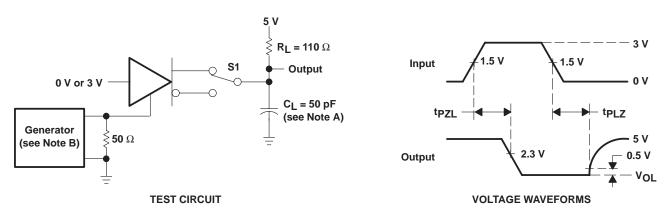


Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle,  $t_\Gamma \leq$  6 ns,  $t_f \leq$  6 ns,  $t_C \leq$  0 ns,  $t_C \leq$  0 ns,  $t_C \leq$  1 MHz, 50% duty cycle,  $t_C \leq$  1 ns,  $t_C \leq$  1

Figure 5. Driver Test Circuit and Voltage Waveforms

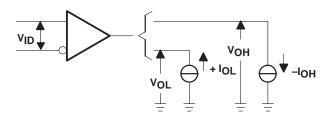
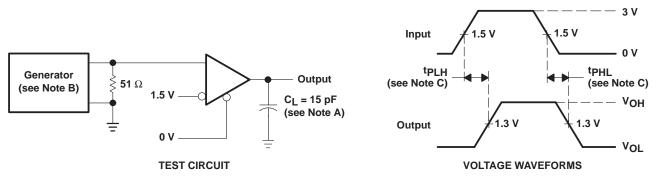


Figure 6. Receiver VOH and VOL Test Circuit



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle,  $t_f \leq$  6 ns,  $t_f \leq$  8 ns,  $t_f \leq$  8 ns,  $t_f \leq$  8 ns,  $t_f \leq$  9 ns

C.  $t_{pd} = t_{PLH}$  or  $t_{PHL}$ 

Figure 7. Receiver Test Circuit and Voltage Waveforms



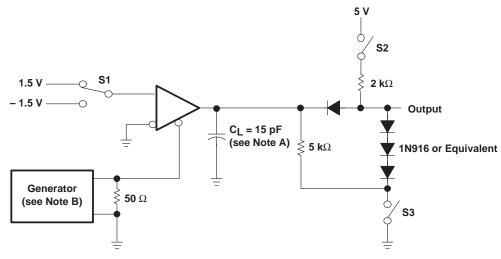
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

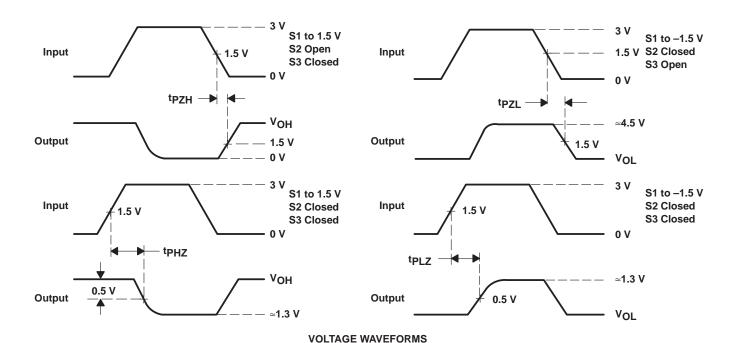
#### SN65ALS176, SN75ALS176, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### PARAMETER MEASUREMENT INFORMATION



**TEST CIRCUIT** 



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle,  $t_f \leq$  6 ns,  $t_f \leq$  8 ns,  $t_f \leq$  9 ns

Figure 8. Receiver Test Circuit and Voltage Waveforms



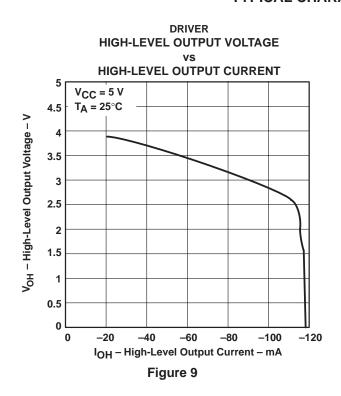


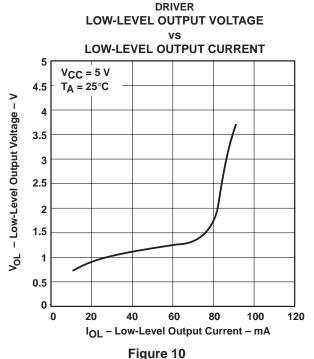
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B **DIFFERENTIAL BUS TRANSCEIVERS**

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### TYPICAL CHARACTERISTICS<sup>†</sup>





# **DRIVER DIFFERENTIAL OUTPUT VOLTAGE** ٧S **OUTPUT CURRENT** T<sub>A</sub> = 25°C

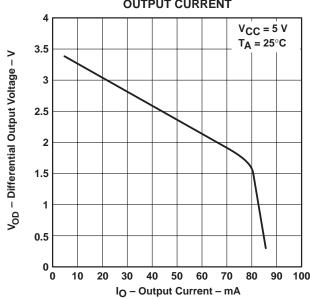


Figure 11

<sup>†</sup> Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

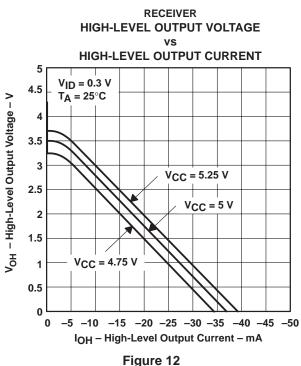
#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

SLLS040H - AUGUST 1987 - REVISED JUNE 2000

**RECEIVER** 

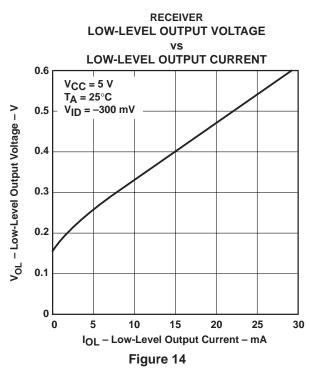
HIGH-LEVEL OUTPUT VOLTAGE

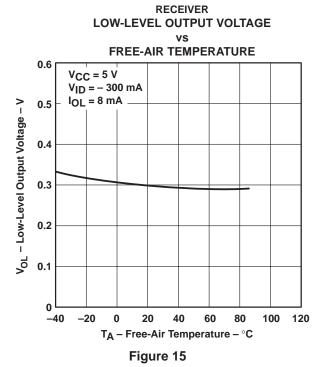
#### RECEIVER TYPICAL CHARACTERISTICS<sup>†</sup>



vs FREE-AIR TEMPERATURE 5  $V_{CC} = 5 V$ 4.5  $V_{ID} = 300 \text{ mV}$ V<sub>OH</sub> - High-Level Output Voltage - V  $I_{OH} = -440 \mu A$ 3.5 3 2.5 2 1.5 1 0.5 0 -40-20 0 20 40 60 80 100 120 T<sub>A</sub> – Free-Air Temperature – °C Figure 13







<sup>†</sup> Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

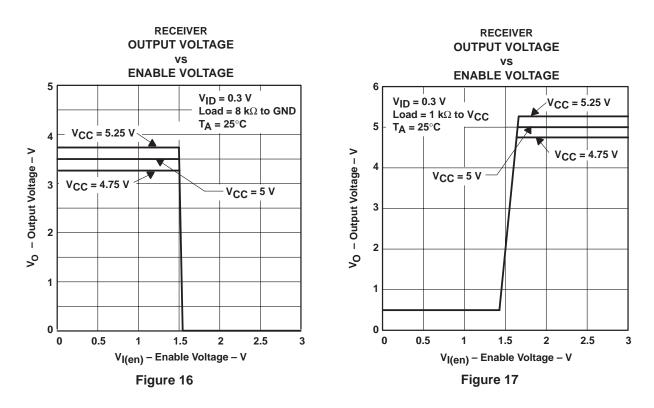


Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### SN65ALS176, SN75ALS176, SN75ALS176A, SN75ALS176B DIFFERENTIAL BUS TRANSCEIVERS

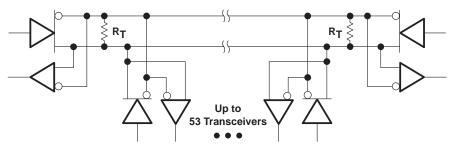
SLLS040H - AUGUST 1987 - REVISED JUNE 2000

#### TYPICAL CHARACTERISTICS<sup>†</sup>



† Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

#### **APPLICATION INFORMATION**



NOTE A: The line should terminate at both ends in its characteristic impedance (R<sub>T</sub> = Z<sub>O</sub>). Stub lengths off the main line should be kept as short as possible.

Figure 18. Typical Application Circuit





Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to Tl's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



# **PACKAGE OPTION ADDENDUM**

23-Apr-2007

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN65ALS176D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN65ALS176P	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI
SN75ALS176AD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176ADE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176ADG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176ADR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176ADRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176ADRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176AP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS176APE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS176BD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176BP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS176BPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS176D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



#### **PACKAGE OPTION ADDENDUM**

23-Apr-2007

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN75ALS176DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS176P	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS176PE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND**: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

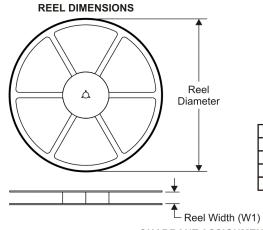
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

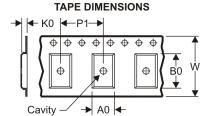


#### **PACKAGE MATERIALS INFORMATION**

19-Mar-2008

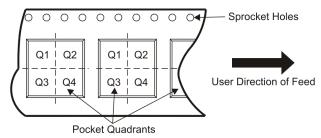
#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65ALS176DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176BDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

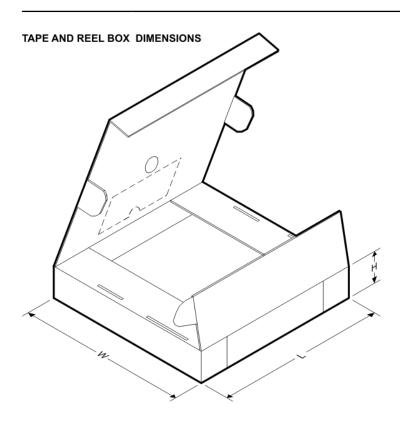
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



# **PACKAGE MATERIALS INFORMATION**

19-Mar-2008



#### \*All dimensions are nominal

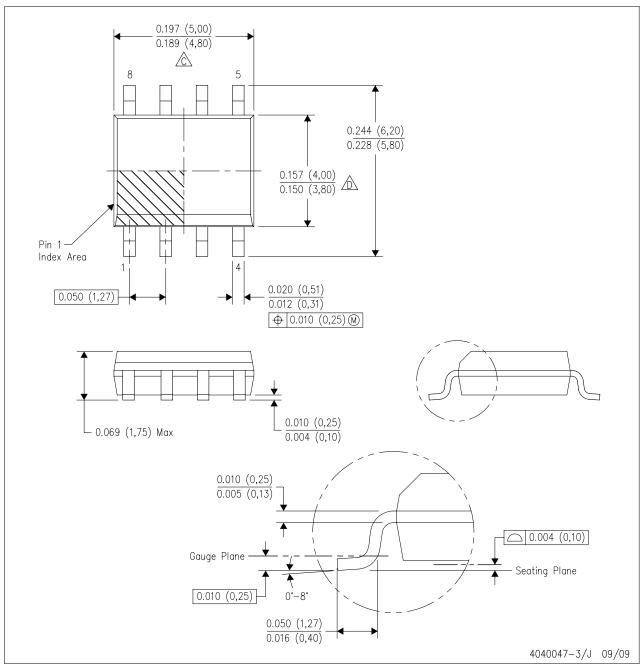
7 th difficilisions are norminal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN65ALS176DR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176ADR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176BDR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176DR	SOIC	D	8	2500	340.5	338.1	20.6



#### **MECHANICAL DATA**

# D (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.





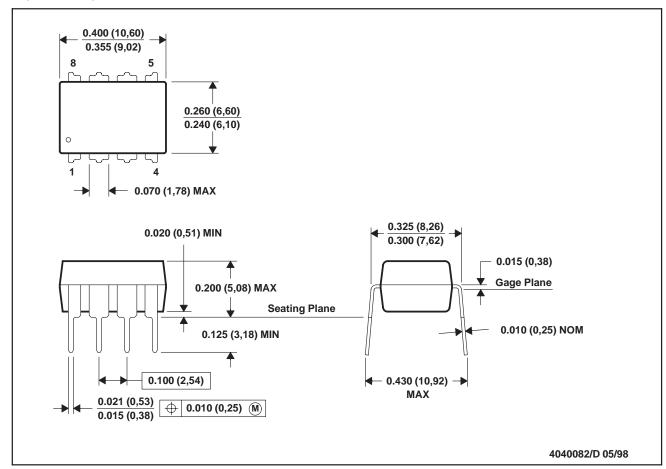
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### **MECHANICAL DATA**

MPDI001A - JANUARY 1995 - REVISED JUNE 1999

#### P (R-PDIP-T8) PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg\_info.htm





Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### PACKAGE OPTION ADDENDUM

www.ti.com 24-Apr-2015

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
SN65ALS176D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65A176	Samples
SN65ALS176DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65A176	Samples
SN65ALS176DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65A176	Samples
SN65ALS176DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	65A176	Samples
SN65ALS176P	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI	-40 to 85		
SN75ALS176AD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176A	Samples
SN75ALS176ADG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176A	Samples
SN75ALS176ADR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176A	Samples
SN75ALS176ADRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176A	Samples
SN75ALS176ADRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176A	Samples
SN75ALS176AP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	75ALS176A	Samples
SN75ALS176BD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176B	Samples
SN75ALS176BDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176B	Samples
SN75ALS176BDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176B	Samples
SN75ALS176BDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176B	Samples
SN75ALS176BDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7A176B	Samples
SN75ALS176BP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	75ALS176B	Samples

Addendum-Page 1



#### **Distributor of Texas Instruments: Excellent Integrated System Limited** Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

24-Apr-2015

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN75ALS176D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75A176	Samples
SN75ALS176DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	75A176	Samples
SN75ALS176P	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	75ALS176	Samples
SN75ALS176PE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	75ALS176	Samples

(1) The marketing status values are defined as follows: ACTIVE: Product device recommended for new designs.

ACTIVE: Froud device recommended in the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and

Addendum-Page 2



Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

www.ti.com 24-Apr-2015

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Addendum-Page 3

Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

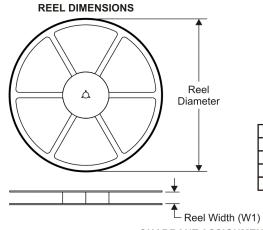
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

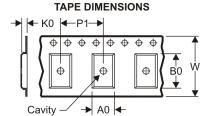


#### **PACKAGE MATERIALS INFORMATION**

19-Mar-2008

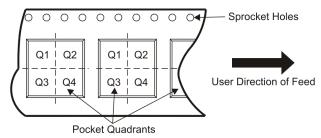
#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65ALS176DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176BDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
SN75ALS176DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

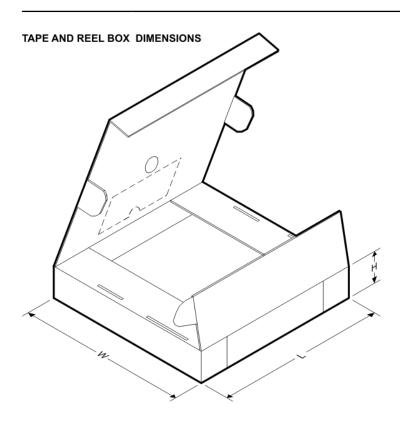
Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



# **PACKAGE MATERIALS INFORMATION**

19-Mar-2008



#### \*All dimensions are nominal

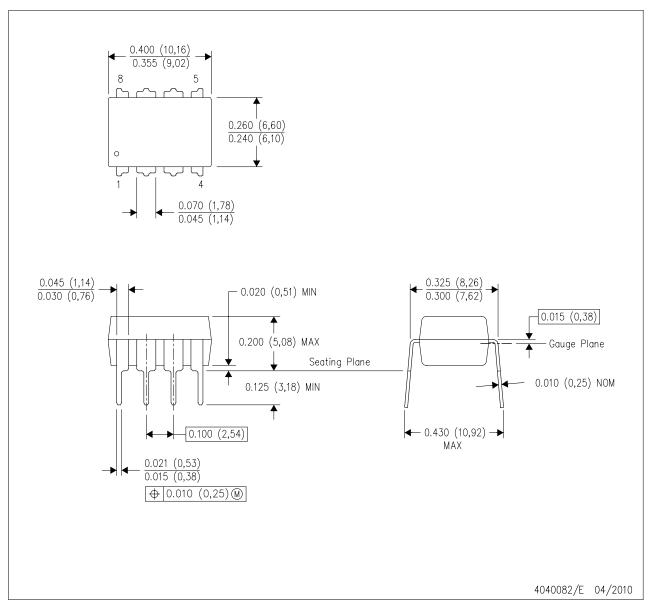
7 th difficilisions are norminal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN65ALS176DR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176ADR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176BDR	SOIC	D	8	2500	340.5	338.1	20.6
SN75ALS176DR	SOIC	D	8	2500	340.5	338.1	20.6



#### **MECHANICAL DATA**

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.

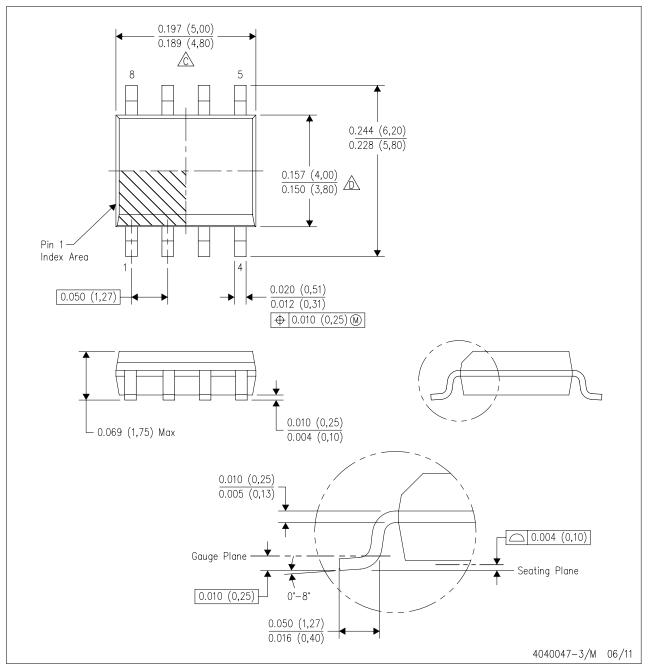




#### **MECHANICAL DATA**

# D (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.



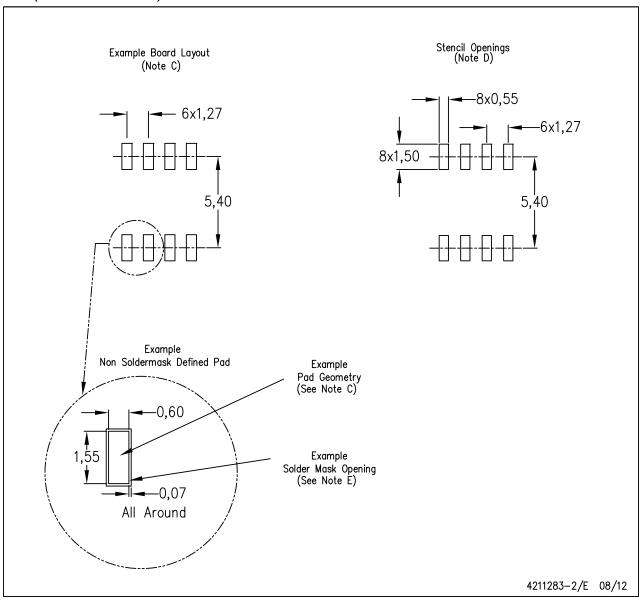




#### LAND PATTERN DATA

# D (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





Datasheet of SN75ALS176D - IC DIFF BUS TRANSCEIVER 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

#### Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial

Interface interface.ti.com Medical www.ti.com/medical Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID www.ti-rfid.com

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated